SDLS172 OCTOBER 1976 - REVISED MARCH 1988

- Three-State, 4 Bit, Cascadable, Parallel-In, Parallel-Out Registers
- 'LS395A Offers Three Times the Sink-Current Capability of 'LS395
- Low Power Dissipation . . . 75 mW Typical (Enabled)
- Applications: N-Bit Serial-To-Parallel Converter N-Bit Parallel-To-Serial Converter N-Bit Storage Register

#### description

These 4-bit registers feature parallel inputs, parallel outputs, and clock (CLK), serial (SER), load shift (LD/ $\overline{SH}$ ), output control ( $\overline{OC}$ ) and direct overriding clear ( $\overline{CLR}$ ) inputs.

Shifting is accomplished when the load/shift control is low. Parallel loading is accomplished by applying the four bits of data and taking the load/shift control input high. The data is loaded into the associated flip-flops and appears at the outputs after the high-to-low transition of the clock input. During parallel loading, the entry of serial data is inhibited.

When the output control is low, the normal logic levels of the four outputs are available for driving the loads or bus lines. The outputs are disabled independently from the level of the clock by a high logic level at the output control input. The outputs then present a high impedance and neither load nor drive the bus line; however, sequential operation of the registers is not affected. During the high-impedance mode, the output at  $Q_D'$  is still available for cascading.

logic symbol<sup>†</sup>



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Taxes Instruments	TEVAS	- <b>i</b> ja	

SN54LS395A .	J or w package
SN74LS395A .	d or n package
(TO	IP view)
CLR []1 SER []2 A []3 B []4 C []5 C []6 LD/SH []7 GND []8	$ \begin{array}{c} 16 \\ 15 \\ 15 \\ 0A \\ 14 \\ 0B \\ 13 \\ 0C \\ 12 \\ 0D \\ 11 \\ 0D' \\ 10 \\ CLK \\ 9 \\ \overline{0C} \end{array} $

SN54LS395A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs





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FUNCTION TABLE

		INPUTS					_	3-51	ATE	OUTP	UTS	CASCAD
			000	PA	R/	LL	EL	~	_	-	-	OUTPUT
CLH	LD/SH	CLK	SEH	A	8	С	D		αB	чс	αD	a <sub>D</sub> '
L	×	×	×	X	х	х	х	L	L	Ļ	L	Ĺ
н	н	н	х	X	х	x	х	a <sub>A0</sub>	QB0	$Q_{CO}$	$Q_{D0}$	0 <sub>D0</sub>
н	н	L I	x	а	ь	с	d	a	ь	с	d	d
н	L	н	x	X	х	х	х	QA0	a <sub>B0</sub>	$a_{C0}$	$a_{D0}$	$\alpha_{D0}$
н	L	1	н	X	х	х	х	н	QAn	QBn	a <sub>Cn</sub>	Q <sub>Cn</sub>
н	L	1	L	X	х	х	х	L	a <sub>An</sub>	QBn	OCn	a <sub>Cn</sub>

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)					,		•	•				-				7 V
Input voltage									-							7 V
Operating free-air temperature range: SN54LS395A	,								-				5	5°C	to :	125°C
SN74LS395A														$0^{\circ}$	C to	₀ 7 <b>0°</b> C
Storage temperature range													6	6° C	; to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

		SN	54LS39	95A	SN	174LS39	95A	
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, VCC		4.5	5	5.5	4.75	5	5.25	v
	0 <sub>A</sub> , 0 <sub>B</sub> , 0 <sub>C</sub> , 0 <sub>D</sub>			-1			-2.6	mA
High ver output current, IOH				-400			-400	μA
	0 <sub>A</sub> , 0 <sub>B</sub> , 0 <sub>C</sub> , 0 <sub>D</sub>			12			24	mA
	QD,			4	_		8	mA
Clock frequency, fclock		0	_	30	0		30	MHz
Width of clock pulse, tw{clock}		16			16			ns
Sature time high laugh an laug laugh data a	LD/SH	40			40			
Setup time, high-level or low-level data, t <sub>su</sub>	All other inputs	20			20			<b>FF</b>
Hold time, high-level or low-level data, th		10			10			n5
Operating free-air temperature, TA		-55		125	0		70	°C

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electrical characteristics over recommend	ed operating free-air	temperature range (u	nless otherwise noted)
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		750			St	V54LS3	95A	SI	V74LS39	95A	
	PARAMETER	(ES	CONDITION	151	MIN	τγρ‡	MAX	MIN	TYP <sup>‡</sup>	MAX	
⊻ін	High-level input voltage				2			2			V
VIL	Low-level input voltage		······································				0.7			0,8	V
Vік	Input clamp voltage	V <sub>CC</sub> = MIN,	lj = -18 mA	\			-1.5			-1.5	V
∨он	High-level output voltage	Vcc = MIN,	V <sub>IH</sub> = 2 V,	0 <sub>A</sub> , 0 <sub>B</sub> , 0 <sub>C</sub> , 0 <sub>D</sub>	2.4	3.4		2.4	3.1		v
			IOH - MAY	QD,	2.5	3.4		2.7	3.4	2.02	V
		Maa → MIN	Q <sub>A</sub> , Q <sub>B</sub> ,	10L = 12 mA		0.25	0.4		0.25	0.4	
			ac, ap	IOL = 24 mA					0.35	0.5	1 °
VOL	Low-rever on that vortage		001	IOL = 4 mA	<u> </u>	0.25	0.4		0.25	0.4	1
		VIH - 2 V	с. 	IOL = 8 mA					0.35	0.5	l.`_
	Off-state output current,	V <sub>CC</sub> = MAX,	VIH = 2 V,	0 <sub>A</sub> , 0 <sub>B</sub> ,			20			20	A
iozh	high-level voltage applied	V <sub>O</sub> = 2.7 V		ac, ap			20			20	μ.Α.
4	Off-state output current,	VCC = MAX,	VIH = 2 V,	0 <sub>A</sub> , 0 <sub>B</sub> ,			-20				
OZL	low-level voltage applied	Vo = 0.4 V		a <sub>c</sub> , a <sub>D</sub>			-20			-20	24
1 <sub>1</sub>	input current at maximum input voltage	V <sub>CC</sub> = MAX,	V1 = 7 V				0.1			0.1	mΑ
ЧH	High-level input current	V <sub>CC</sub> = MAX,	VI = 2.7 V				20			20	μA
11	Low-level input current	VCC = MAX,	VI = 0.4 V				-0.4			-0.4	mA
				QA, QB,	-30		-130	-30		-130	mA
los	Short-circuit output currents						100			100	
					-20		-100	-20		-100	mA
Icc.	Supply current	V <sub>CC</sub> = MAX,	See Note 2	Condition A		- 22	34		22	34	mA
~~				Condition B		21	31		Z1	31	

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with the outputs open, the serial input and mode control at 4.5 V, and the data inputs grounded under the following conditions:

A. Output control at 4.5 V and a momentary 3 V, then ground, applied to clock input.

Output control and clock input grounded.

# switching characteristics, V\_{CC} = 5 V, T<sub>A</sub> = 25° C

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
fmax	Maximum clock frequency	See Note 2	30	45		MHz
TPHL	Propagation delay time, high-to-low-level output from clear			22	35	ns
<b>TPLH</b>	Propagation delay time, low-to-high-level output	$\Delta A, \Delta B, \Delta C, \Delta D$ of points.		15	30	ns
TPHL_	Propagation delay time, high-to-low-level output			20	30	ns
<sup>t</sup> PZH	Output enable time to high level	Q) outpot. P: = 2 kΩ C: = 15 p€		15	25	ns
<sup>t</sup> PZL	Output enable time to low level			17	25	ns
<sup>t</sup> PHZ	Output disable time from high level	Сլ = 5 рҒ,		11	17	ns
<sup>t</sup> PLZ	Output disable time from low level	See Note 3		12	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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